

RX62T

MTU3 Phase Counting Mode

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Introduction

The RX62T Group has on-chip multi-function timer pulse unit 3 (MTU3), which comprises eight 16-bit timer channels.

Target Device

RX62T

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1. Specification

- Comprises eight 16-bit channels
- Operating frequency is 8 to100 MHz
- [Channels 0 to 4, 6, and 7]
- Waveform output on compare match
- Input capture function
- Counter-clearing operation
- Simultaneous writing to multiple timer counters (TCNT)
- Simultaneous clearing on compare match or input capture
- Simultaneous input and output to registers in synchronization with counter operations
- Up to 12-phase PWM output in combination with synchronous operation
- [Channels 0, 3, 4, 6, and 7]
- Buffer operation specifiable
- [Channels 3, 4, 6, and 7]
- Through interlocked operation of channels 3 and 4 or 6 and 7, output of positive and negative signals in six phases (for a total of 12 phases) in Complementary -PWM and reset-PWM operation
- In Complementary PWM mode, transfer of values from buffer registers to temporary registers on peaks and troughs of the timer-counter values or writing to the buffer registers (MTU3_4.TGRD and MTU3_7.TGRD)
- Double-buffering selectable in Complementary PWM mode
- [Channels 3 and 4]
- Through interlocking with channel 0, a mode for driving AC synchronous motors (brushless DC motors) by using Complementary PWM output and reset PWM output is settable and allows the selection of two types of waveform output (chopping or level)
- [Channels 1 and 2]
- Independently specifiable phase-counting mode
- Capable of cascade-connected operation
- [Channel 5]
- Capable of operation as a dead-time compensation counter

Fig. 1-1 is the block diagram of Multi-Function Timer Pulse Unit 3 (MTU3).

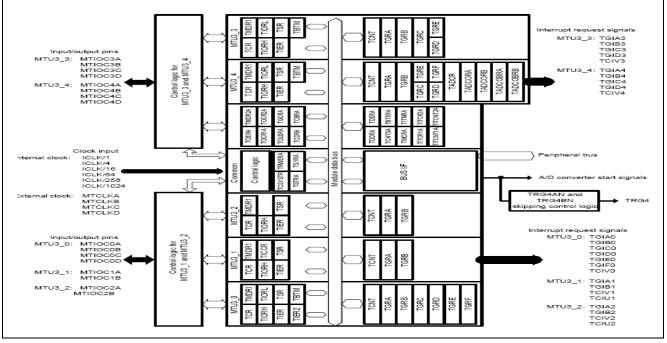


Figure 1-1 Block diagram for MTU3



Table 1-1 Specifications of Multi-Function Timer Pulse Unit 3 (MTU3) Register

TSTR	Timer start register						
TOERA	Timer output master enable register A						
TGCRA	Timer gate control register A						
TOCR1A	Timer output control register 1A						
TOCR2A	Timer output control register 2A						
TCDRA	Timer cycle data register A						
TDDRA	Timer dead time data register A						
TCNTSA	Timer subcounter A						
TCBRA	Timer cycle buffer register A						
TITCR1A	Timer interrupt skipping set register 1A						
TITCR2A	Timer interrupt skipping set register 2A						
TITCNT1A	Timer interrupt skipping set register 2/Y						
TITCNT2A	Timer interrupt skipping counter 114 Timer interrupt skipping counter 2A						
TBTERA	Timer buffer transfer set register A						
TOLBRA	Timer output level buffer register A						
TCR	Timer control register						
TMDR1	Timer mode register 1						
TMDR1 TMDR2A	Timer mode register 1 Timer mode register 2A						
TIORH	Timer I/O control register H						
TIORL	Timer I/O control register L						
TIER	Timer interrupt enable register						
TCNT	Timer counter						
TGRA	Timer general register A						
TGRB	Timer general register B						
TGRC	Timer general register D						
TGRD	Timer general register D						
TGRE	Timer general register E						
TGRE	Timer general register F						
TSR	Timer status register						
TDERA	Timer dead time enable register A						
	Timer buffer operation transfer mode						
TBTM	register						
TADCD	Timer A/D converter start request						
TADCR	control register						
TADCORA	Timer A/D converter start request cycle						
	set register A						
TADCORB	Timer A/D converter start request cycle set register B						
	Timer A/D converter start request cycle						
TADCOBRA	set buffer register A						
TADCODDD	Timer A/D converter start request cycle						
TADCOBRB	set buffer register B						



2. Multi-Function Timer Pulse Unit 3 for Phase Counting Mode

2.1 Example of Phase Counting Mode operation

In phase counting mode, the phase difference between two external input clocks is detected and TCNT is incremented or decremented accordingly. This mode can be set for channels 1 and 2.

When phase counting mode is specified, an external clock is selected as the counter input clock and TCNT operates as an up/down-counter regardless of the setting of bits TPSC[2:0] and bits CKEG[1:0] in TCR. However, the functions of bits CCLR[1:0] in TCR and of TIOR, TIER, and TGR are valid, and input capture/compare match and interrupt functions can be used.

This can be used for two-phase encoder pulse input.

If an overflow occurs while TCNT is counting up, the TCFV flag in TSR is set to 1. If an underflow occurs while TCNT is counting down, the TCFU flag is TSR is set to 1.

The TCFD flag in TSR is the count direction flag. Read the TCFD flag to check whether TCNT is counting up or down.

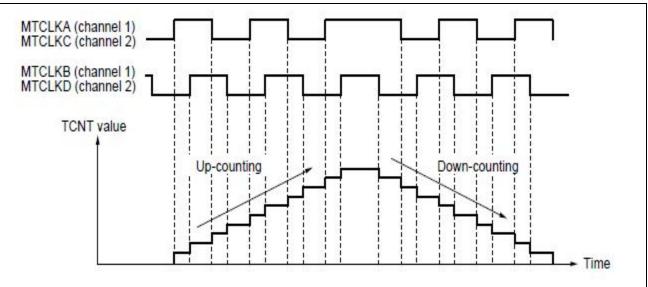


Fig. 2-1 shows an example of Phase Counting Mode operation.

Figure 2-1 Example of Phase Counting Mode operation



2.2 Example of Procedure for Setting Phase Counting Mode

Fig. 2-2 shows an example of the procedure for setting Phase Counting Mode.

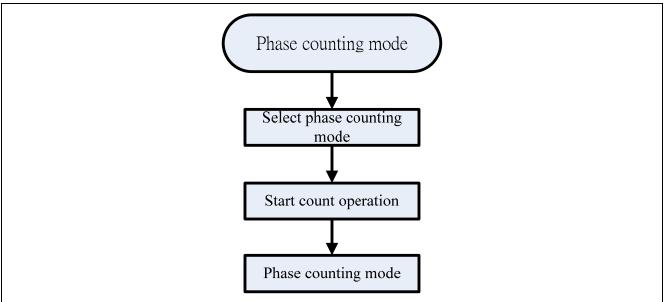


Figure 2-2 Example of Procedure for Setting Phase Counting Mode

2.3 Phase Counting Mode Application Example

Fig. 2-3 shows an example in which channel 1 is in phase counting mode, and channel 1 is coupled with channel 0 to input 2-phase encoder pulses of a servo motor in order to detect position or speed.

Channel 1 is set to phase counting mode, and the encoder pulse A-phase and B-phase are input to MTCLKA and MTCLKB.

In channel 0, MTU0.TGRC compare match is specified as the TCNT clearing source and MTU0.TGRA and MTU0.TGRC are used for the compare match function and are set with the speed control cycle and position control cycle. MTU0.TGRB is used for input capture, with MTU0.TGRB and MTU0.TGRD operating in buffer mode. The channel 1 counter input clock is designated as the MTU3_0.TGRB input capture source, and the widths of 2-phase encoder 4-multiplication pulses are detected.

MTU1.TGRA and MTU1.TGRB for channel 1 are designated for the input capture function and MTU0.TGRA and MTU0.TGRC compare matches in channel 0 are selected as the input capture sources to store the up/down-counter values for the control cycles.

This procedure enables the accurate detection of position and speed.





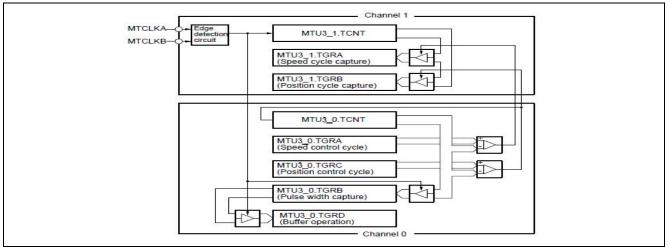


Figure 2-3 Phase Counting Mode Application Example

3. Multi-Function Timer Pulse Unit 3 Software Register Setting

Timer Control Register (TCR):

TCR controls the TCNT operation for each channel. The MTU has a total of ten TCR registers, one each for channels 0 to 4, 6, and 7. TCR values should be specified only while TCNT operation is stopped.

Va	alue after reset:	0		1750	S					
		. 0	0	0	0	0	0	0	0	
Bit	Symbol	Bit Name		Des	cription					R/W
b2 to b0	TPSC[2:0]	Time Prescaler	Select	See	tables 15.7 t	o 15.10.				R/W
b4, b3	CKEG[1:0]	Clock Edge Sel	ect	b4 b	b4 b3					R/W
				0 0: Count at rising edge 0 1: Count at falling edge						
				1 x:	Count at bot	n edges				
b7 to b5	CCLR[2:0]	Counter Clear		See	tables 15.5 a	and 15.6.				R/W

Figure 3-1 TCR Setting

Timer General Register (TGR):

TGR is a 16-bit readable/writable register.

TGRA, TGRB, TGRC, and TGRD function as either output compare or input capture registers. TGRC and TGRD for channels 0, 3, 4, 6, and 7 can also be designated for operation as buffer registers. TGR buffer register combinations are TGRA and TGRC, and TGRB and TGRD.



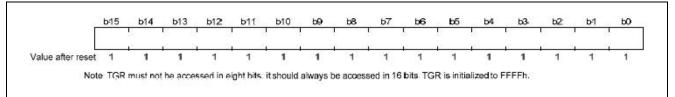


Figure 3-2 TGR Setting

Timer Mode Register (TMDR):

TMDR1 specifies the operating mode of each channel. The MTU3 has a total of seven TMDR1 registers, one each for channels 0 to 4, 6, and 7. TMDR1 values should be specified only while TCNT operation is stopped.

		b7	b6	b5	ь4	Ь3	ь2	b1	ьо	
		-		BFB	BFA		MD[3:0]			
Val	lue after reset:	0	0	0	0	0	0	0	0	6
Bit	Symbol	Bit Name		Descript	ion					R/W
b3 to b0	MD[3:0]	Mode Select		These bit	s specify the	timer operati	ng mode. Se	e table 15.12	2 for details.	R/W
b4	BFA	Buffer Operation	A	0: TGRA	and TGRC of	perate norma	ally			R/W
				1: TGRA	and TGRC us	sed together	for buffer op	eration		
b5	BFB	Buffer Operation	B	0: TGRB	and TGRD o	perate norma	ally			R/W
				1: TGRB	and TGRD us	sed together	for buffer op	eration		
b6	BFE	Buffer Operation	E	0: MTU3_	0.TGRE and	MTU3_0.TO	RF operate	normally		R/W
				1: MTU3_	0.TGRE and	MTU3_0.TO	RF used tog	ether for buf	fer	
				operati	on	5.30				
b7		(Reserved)		This bit is	always read	as 0. The w	rite value sho	uld be 0.		R/W

Figure 3-3 TMDR Setting

4. Experimental Result

Fig. 4-1shows an example of operation in phase counting mode 1, and variable A in sample code summarizes the TCNT up-count/down-count conditions.

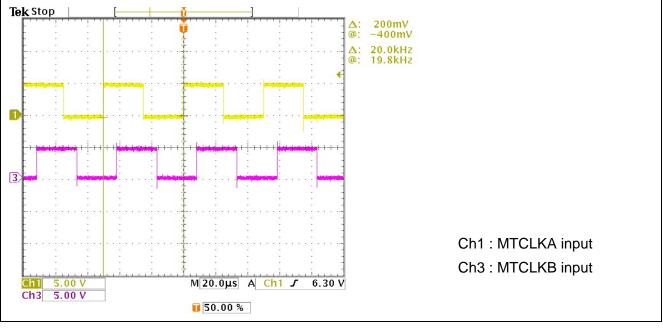






Fig. 4-2 shows an example of operation in phase counting mode 2, and variable A in sample code summarizes the TCNT up-count/down-count conditions.

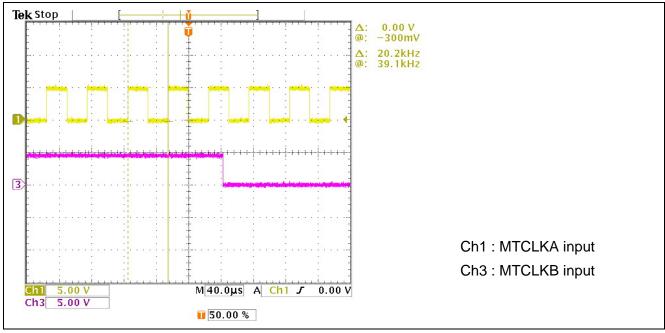




Fig. 4-3 shows an example of operation in phase counting mode 3, and variable A in sample code summarizes the TCNT up-count/down-count conditions.

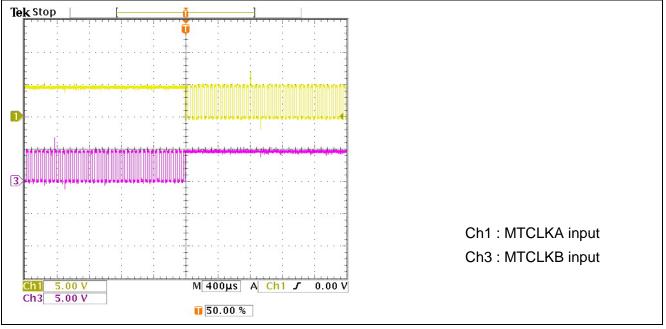


Figure 4-3 MTCLKA and MTCLKB input for encoder pulse



Fig. 4-4 shows an example of operation in phase counting mode 4, and variable A in sample code summarizes the TCNT up-count/down-count conditions.

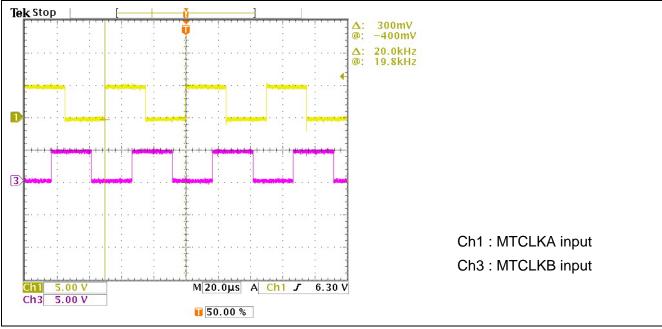


Figure 4-4 MTCLKA and MTCLKB input for encoder pulse

5. Conclusion

We can use Multi-Function Timer Pulse Unit 3 for Phase Counting Mode control.

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Revision Record

		Descript	ion
Rev.	Date	Page	Summary
1.00	October 1. 11	_	First edition issued

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1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.
- 2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
 In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.
 In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at
- which resetting has been specified.
- 3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access
 these addresses; the correct operation of LSI is not guaranteed if they are accessed.
- 4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal.
 Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.
- 5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

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Renesas Electronics Corporation

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 Renesse Electronics America Inc.

 2880 Scott Boilevard Santa Clara, CA 95050-2554, U.S.A.

 Tei: +1-409-588-0000, Fax: +14-08-588-6130

 Renesse Electronics Canada Limited

 1011 Nicholson Road, Newmarket, Ontario L3Y 9C3, Canada

 Tei: +1-905-888-5441, Fax: +1-905-898-3220

 Renesse Electronics Europe Limited

 Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K

 Tei: +44-1628-585-100, Fax: +444-1628-585-900

 Renesse Electronics Europe GmbH

 Arcadiastrasse 10, 40472 Düsseldorf, Germany

 Tei: +49-211-65030, Fax: +449-211-6503-1327

 Renesse Electronics (China) Co., Ltd.

 Th Floor, Quantum Plaza, No.27 ZhiChunLu Haidian District, Beijing 100083, P.R.China

 Tei: +49-214-55030, Fax: +480-2835-7670

 Renesse Electronics (Shanghai) Co., Ltd.

 Unit 204, 205, AzIA Center, No. 1233 Luijazui Ring Rd., Pudong District, Shanghai 200120, China

 Tei: +49-21-5877-1818, Fax: +852-1887-7858 / -7898

 Renesse Electronics Hong Kong Limited

 Unit 101-103, 16/FL, Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong

 Tei: +862-24175-9900, Fax: +862 2-8175-9670

 Renesse Electronics Taiwan Co., Ltd.

 137, No. 363, Fu Shing North Road, Taipei, Taiwan

 Tei: +862-24175-9900, Fax: +863 2-4175-9870

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